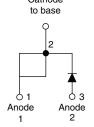


Vishay High Power Products

HEXFRED® Ultrafast Soft Recovery Diode, 8 A





TO-247AC modified

PRODUCT SUMMARY					
V_{R}	1200 V				
V _F at 8 A at 25 °C	3.3 V				
I _{F(AV)}	8 A				
t _{rr} (typical)	28 ns				
T _J (maximum)	150 °C				
Q _{rr} (typical)	140 nC				
dI _{(rec)M} /dt (typical) at 125 °C	85 A/µs				
I _{RRM} (typical)	4.5 A				

FEATURES

- · Ultrafast recovery
- · Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- · Specified at operating conditions
- · Designed and qualified for industrial level

BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- · Higher frequency operation
- · Reduced snubbing
- · Reduced parts count

DESCRIPTION

HFA08PB120 is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 8 A continuous current, the HFA08PB120 is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA08PB120 is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V_R		1200	V	
Maximum continuous forward current	I _F	T _C = 100 °C	8		
Single pulse forward current	I _{FSM}		130	Α	
Maximum repetitive forward current	I _{FRM}		32		
Maximum navar discipation	P _D	T _C = 25 °C	73.5	W	
Maximum power dissipation		T _C = 100 °C	29	1 vv	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	Ι _R = 100 μΑ		1200	-	-	
	I _F = 8.0 A		-	2.6	3.3	V	
Maximum forward voltage V _{FI}	V_{FM}	I _F = 16 A	See fig. 1	-	3.4	4.3	
		I _F = 8.0 A, T _J = 125 °C		-	2.4	3.1	
Maximum reverse		$V_R = V_R$ rated	See fig. 2	-	0.31	10	
leakage current	I _{RM}	$T_J = 125 ^{\circ}\text{C}, V_R = 0.8 \text{x} V_R \text{rated}$	See lig. 2	-	135	1000	μΑ
Junction capacitance	C _T	V _R = 200 V	See fig. 3	=	11	20	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body - 8.0 -		=	nH		

DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		I _F = 1.0 A, dI _F /dt = 200 A/μs, V _R = 30 V		-	28	-	
Reverse recovery time See fig. 5, 10	t _{rr1}	T _J = 25 °C		-	63	95	ns
occ lig. 5, 10	t _{rr2}	T _J = 125 °C	$I_F = 8.0 \text{ A}$ $dI_F/dt = 200 \text{ A/µs}$ $V_R = 200 \text{ V}$	-	106	160	
Peak recovery current	I _{RRM1}	T _J = 25 °C		-	4.5	8.0	А
See fig. 6	I _{RRM2}	T _J = 125 °C		-	6.2	11	
Reverse recovery charge	Q _{rr1}	T _J = 25 °C		-	140	380	nC
See fig. 7	Q _{rr2}	T _J = 125 °C		-	335	880	nc
Peak rate of recovery	dI _{(rec)M} /dt1	T _J = 25 °C		-	133	-	A/μs
current during t _b See fig. 8	dI _{(rec)M} /dt2	T _J = 125 °C		-	85	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Thermal resistance, junction to case	R _{thJC}		-	-	1.7	
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	40	K/W
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.25	-	
Weight			-	6.0	-	g
vveignt			-	0.21	-	OZ.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style TO-247AC modified (JEDEC)		HFA08	3PB120	

Document Number: 93037 Revision: 30-Jul-08



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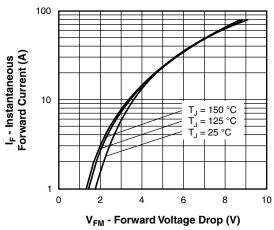


Fig. 1 - Maximum Forward Voltage Drop Characteristics

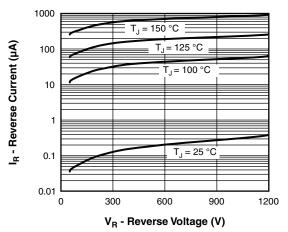


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

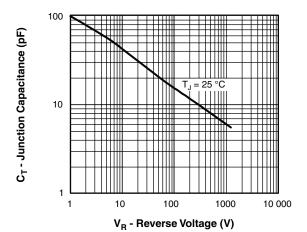


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

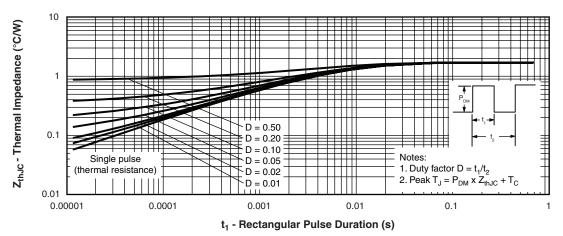


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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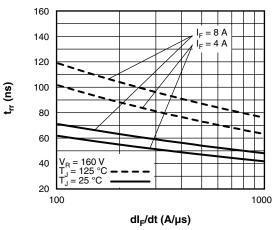


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt

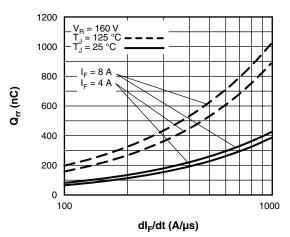


Fig. 7 - Typical Stored Charge vs. dl_F/dt

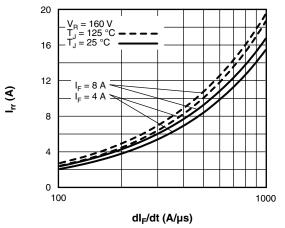


Fig. 6 - Typical Recovery Current vs. dl_F/dt

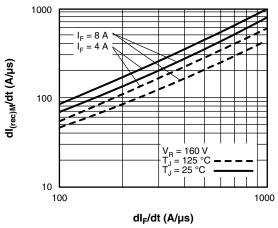


Fig. 8 - Typical $dl_{(rec)M}/dt$ vs. dl_F/dt



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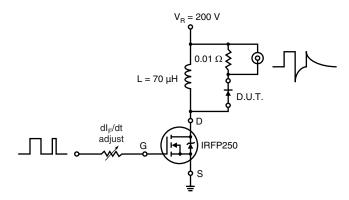
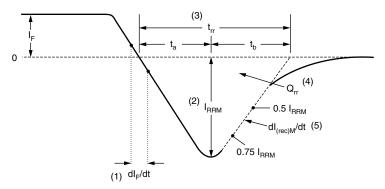


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm I_{r}$ to point where a line passing through 0.75 $\rm I_{RRM}$ and 0.50 $\rm I_{RRM}$ extrapolated to zero current.
- (4) $\mathbf{Q}_{\rm rr}$ area under curve defined by $\mathbf{t}_{\rm rr}$ and $\mathbf{I}_{\rm RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

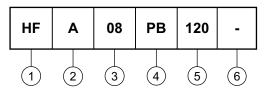
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ORDERING INFORMATION TABLE

Device code



1 - HEXFRED® family

2 - Process designator: A = Electron irradiated

B = Platinum diffused

3 - Current rating (08 = 8 A)

4 - Package outline (PB = TO-247, 2 pins)

5 - Voltage rating (120 = 1200 V)

- • None = Standard production

• PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95253				
Part marking information	http://www.vishay.com/doc?95255			

Document Number: 93037 Revision: 30-Jul-08



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Document Number: 91000 Revision: 18-Jul-08